



ITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: KIRA, et al.

Serial No.: 09/548,313

Filed: April 12, 2000

Group Art Unit: 2652

Examiner: Craig A. Renner

P.T.O. Confirmation No.: 6169

For: HEAD ASSEMBLY HAVING INTEGRATED CIRCUIT CHIP COVERED BY LAYER WHICH PREVENTS FOREIGN PARTICLE GENERATION

RESPONSE UNDER 37 CFR §1.116
- EXPEDITED RESPONSE GROUP ART UNIT 2652

RECEIVED

JUN 1 4 2004

Technology Center 2600

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

MAIL STOP AF

June 8, 2004

Sir:

In response to the Office Action dated **April 23, 2004**, please amend the above-identified application as follows:

De Nothor